

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Li-Qun Wang	02/15/2008
RECEIVING PARTY DATA	
Name:	Dalian Talent Gift Co., Ltd.
Street Address:	TangFang
City:	TaiPing Village, PuLanDian, LiaoNing
State/Country:	CHINA
Postal Code:	116200
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	D543292
CORRESPONDENCE DATA	
Fax Number:	(323)210-7283
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	+81-58-276-2175
Email:	crapenhof@hiroco.jp
Correspondent Name:	Michael L. Crapenhof
Address Line 1:	4-3, Usa 3-chome
Address Line 2:	c/o Hiroe & Associates
Address Line 4:	Gifu City, JAPAN 500-8368
ATTORNEY DOCKET NUMBER:	GENERAL - BTA
NAME OF SUBMITTER:	Michael L. Crapenhof
Total Attachments: 1 source=dalian talent gift design assignment-US#page1.tif	

OP \$40.00 D543292

ASSIGNMENT OF PATENT RIGHTS

FOR VALUE RECEIVED, I, Li-qun WANG, an individual person with an address at No. 8 TuanJie Street, XiGang District, DaLian, LiaoNing Province 116011 CHINA, do hereby sell, assign, transfer and convey unto DALIAN TALENT GIFT CO., LTD., a corporation of CHINA with a business address at TangFang, TaiPing Village, PuLanDian, LiaoNing Province, 116200, CHINA, and its successors, assigns and legal representatives (hereinafter called the "Assignee"), my entire right, title and interest, for the United States, in and to the design described and claimed in United States Design Patent No. D543,292, entitled SURFACE ORNAMENTATION FOR CANDLE.

I further assign all rights in and to said patent, and any divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues and extensions thereof, and I hereby authorize and request the Commissioner for Patents and Trademarks of the United States to issue all Letters Patents upon said further applications to the Assignee or to such nominees as it may designate.

AND I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file, or like document which may be required in the United States for any purpose.

AND I hereby covenant that I have the full right to convey the entire right, title and interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I hereby covenant and agree that I will communicate to said Assignee or its nominees all facts known to me pertaining to said patent and said designs, and testify in all legal proceedings, sign all lawful papers, execute all continuing and reissue applications, make all rightful oaths and declarations and in general perform all lawful acts necessary or proper to aid said Assignee or its nominees in obtaining, maintaining, and enforcing all lawful patent protection for said designs in the United States.

By: _____

Li-Qun WANG

Date: _____

2008. 2. 15